

# MOS INTEGRATED CIRCUIT $\mu$ PD77115, 77115A

# 16-BIT FIXED-POINT DIGITAL SIGNAL PROCESSOR

#### **DESCRIPTION**

The  $\mu$ PD77115 and  $\mu$ PD77115A are 16-bit fixed-point digital signal processors (DSP).

The  $\mu$ PD77115 and  $\mu$ PD77115A are RAM based DSP and have the specific circuit for audio application.

Unless otherwise specified, the  $\mu$ PD77115 refers to  $\mu$ PD77115 and 77115A.

For details of the functions of the  $\mu$ PD77115, refer to the following User's Manuals:

 $\mu$ PD77111 Family User's Manual - Architecture : U14623E  $\mu$ PD77016 Family User's Manual - Instructions : U13116E

#### **FEATURES**

Instruction cycle (operating clock)
 13.3 ns MIN. (75 MHz MAX.)

Memory

Internal instruction RAM
 11.5K words × 32 bits

Internal data RAM
 16K words × 16 bits × 2 banks

Peripherals

· Audio serial interface

· Secure Digital (SD) card interface

• 16-bit timer

· 16-bit host interface

• 8-bit port

Supply voltage

· DSP core voltage

2.0 to 2.7 V (MAX. operation speed 50 MHz)

2.3 to 2.7 V (MAX. operation speed 75 MHz)

I/O pin voltage

2.7 to 3.6 V

Power consumption
 TYP. 50 mW (2.0 V, 50 MHz operation)

#### **ORDERING INFORMATION**

Part Number Package

 $\star$   $\mu$ PD77115F1-CN6 80-pin plastic FBGA (9 × 9)

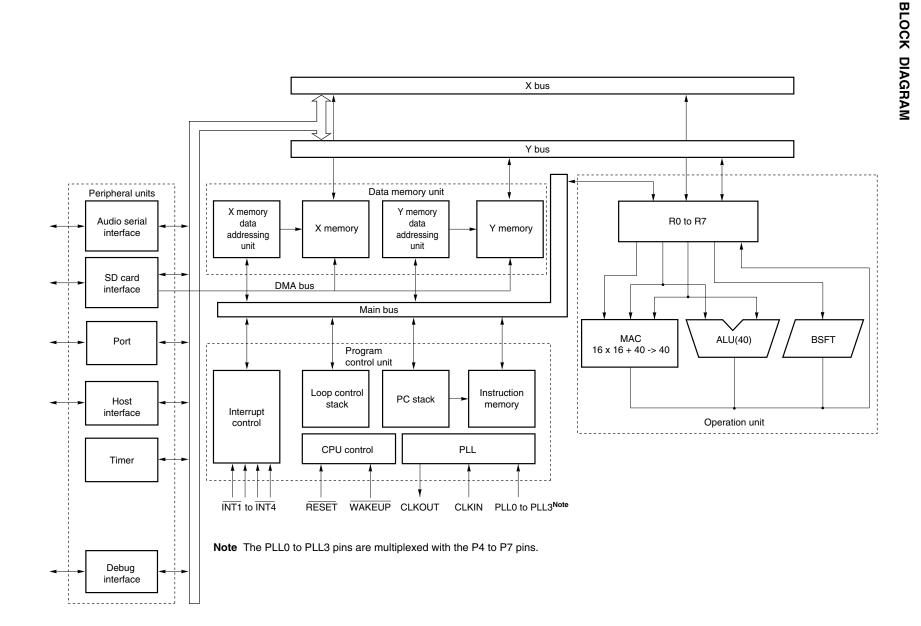
 $\mu$ PD77115GK-9EU 80-pin plastic TQFP (fine pitch) (12 × 12)

★ μPD77115AF1-xxx-CN6 80-pin plastic FBGA (9 × 9)

Remark xxx indicates ROM code suffix.

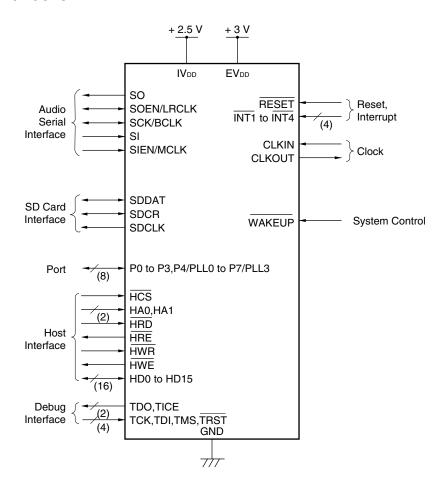
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# **FUNCTION PIN GROUPS**



Remark The P4 to P7 pins are multiplexed with PLL0 to PLL3 pins.

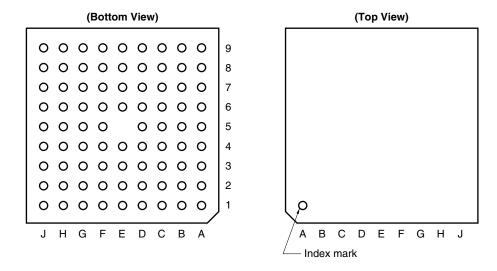
# **≯** DSP FUNCTION LIST

|                           | Item  |  | μPD77111                   | μPD77112                     | μPD77113A               | μPD77114  | μPD77115,77115A                     | μPD77210                                  | μPD77213                             |
|---------------------------|---|--|----------------------------|------------------------------|-------------------------|---|-------------------------------------|---|--------------------------------------|
| Memory                    | Int. instruction RAM                          | 35.5 K × 32                                      | 1 K                        | × 32                         | 3.5 K                   | X × 32  | 11.5 K × 32                         | 31.5 K × 32                               | 15.5 K × 32                          |
| space<br>(words ×         | Int. instruction ROM                          | None   | 31.75                      | K × 32                       | 48 K × 32               |   | No                                  | ne  | 64K × 32                             |
| bits)                     | Data RAM<br>(X/Y memory)                      | 24 K × 16 each                                   | 3 K × 1                    | 16 each                      | 16 K × 16 each          |   | 16 K × 16 each                      | 30 K × 16 each                            | 18 K × 16 each                       |
|                           | Data ROM<br>(X/Y memory)                      | None   | 16 K×                      | 16 each                      | 32 K ×                  | 16 each   | No                                  | ne  | 32 K × 16 each                       |
|                           | Ext. instruction                              |  | 1                          |                              | No                      | one   | •                                   |   |                                      |
|                           | Ext. data memory (X/Y memory)                 | 32 K × 16 each                                   | None                       | 16 K × 16 each               | None                    | 8 K × 16 each                                     | None                                | 1 M×16                                    | 1 M × 16 (8 K ×<br>16, using SD I/F) |
| Instruction coperating sp | ycle (at maximum<br>peed)                     | 15.3 ns<br>(65 MHz)                              |                            |                              | 13.3 ns<br>(75 MHz)     |   | 6.25 ns 8.33 ns (160 MHz) (120 MHz) |   |                                      |
| Multiple                  |   | Integer multiple<br>of ×1 to 8<br>(external pin) |                            | Integer multip<br>(mask      | ole of ×1 to 16 option) | Integer multiple<br>of ×1 to 16<br>(external pin) |                                     | le of ×10 to 64<br>nal pin)               |                                      |
| Peripheral                | Serial interface                              |  |                            | 2 channels<br>(speech CODEC) |                         |   | 1 channel<br>(audio CODEC)          | ` '                                       |                                      |
|                           | Host interface                                |  |                            | 8-bit bus                    |                         |   | 16-bit bus                          |   |                                      |
|                           | General-purpose<br>port (I/O<br>programmable) |  |                            | 4 bits                       |                         |   | 8 bits                              | s 16 bits (some are alternative wit host) |                                      |
|                           | Timer   |  |                            | None                         |                         |   | 1 channel<br>(16-bit resolution)    |   | annels<br>esolution)                 |
|                           | Others  | -  | -                          | -                            | _                       | -   | SD card I/F                         | -   | SD card I/F                          |
| Supply volta              | ge  | DSP core: 2.5 V<br>I/O pins: 3 V                 |                            |                              |                         |   | DSP core: 1.5 V<br>I/O pins: 3 V    |   |                                      |
| Package                   |   | 100-pin TQFP                                     | 80-pin TQFP<br>80-pin FBGA | 100-pin TQFP                 | 80-pin FBGA             | 100-pin TQFP                                      | 80-pin TQFP<br>80-pin FBGA          | 161-pin FBGA<br>144-pin LQFP              |                                      |

# **PIN CONFIGURATIONS**

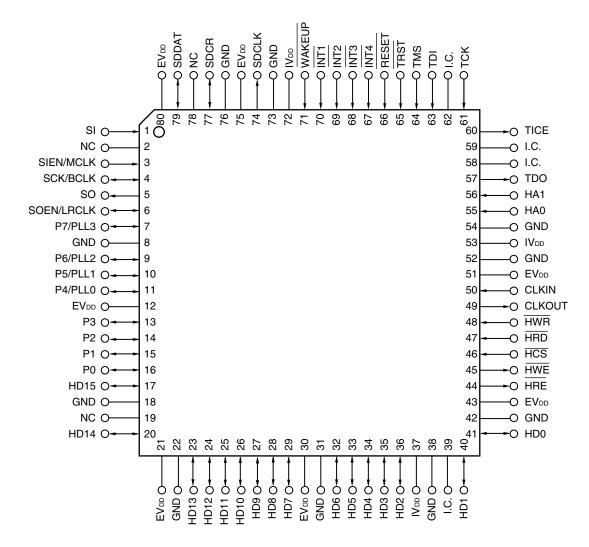
80-pin plastic fine pitch BGA (9  $\times$  9)

- ★ μPD77115F1-CN6
- $\star$   $\mu$ PD77115AF1-xxx-CN6



| Pin No. | Pin Name         | Pin No. | Pin Name   | Pin No. | Pin Name         | Pin No. | Pin Name         |
|---------|------------------|---------|------------|---------|------------------|---------|------------------|
| A1      | EV <sub>DD</sub> | C3      | SDDAT      | E6      | GND              | G8      | HRE              |
| A2      | NC               | C4      | GND        | E7      | HWR              | G9      | EV <sub>DD</sub> |
| А3      | EV <sub>DD</sub> | C5      | INT3       | E8      | EV <sub>DD</sub> | H1      | GND              |
| A4      | IVDD             | C6      | TRST       | E9      | CLKOUT           | H2      | EV <sub>DD</sub> |
| A5      | INT2             | C7      | TICE       | F1      | EV <sub>DD</sub> | H3      | HD12             |
| A6      | RESET            | C8      | TDO        | F2      | P0               | H4      | EV <sub>DD</sub> |
| A7      | TDI              | C9      | HA0        | F3      | P3               | H5      | GND              |
| A8      | I.C.             | D1      | SOEN/LRCLK | F4      | HD9              | H6      | HD2              |
| A9      | I.C.             | D2      | P5/PLL1    | F5      | HD4              | H7      | IVDD             |
| B1      | NC               | D3      | so         | F6      | HRD              | H8      | HD0              |
| B2      | SI               | D4      | P7/PLL3    | F7      | HWE              | H9      | GND              |
| В3      | SDCR             | D5      | SDCLK      | F8      | CLKIN            | J1      | NC               |
| B4      | GND              | D6      | INT4       | F9      | HCS              | J2      | GND              |
| B5      | WAKEUP           | D7      | IVDD       | G1      | P1               | J3      | HD13             |
| B6      | INT1             | D8      | HA1        | G2      | HD15             | J4      | HD10             |
| В7      | TMS              | D9      | GND        | G3      | HD14             | J5      | HD7              |
| B8      | TCK              | E1      | P6/PLL2    | G4      | HD11             | J6      | HD6              |
| В9      | I.C.             | E2      | P4/PLL0    | G5      | HD8              | J7      | HD3              |
| C1      | SIEN/MCLK        | E3      | GND        | G6      | HD5              | J8      | GND              |
| C2      | SCK/BCLK         | E4      | P2         | G7      | HD1              | J9      | I.C.             |

# 80-pin plastic TQFP (fine pitch) (12 $\times$ 12) (Top view) $\mu$ PD77115GK-9EU



| Pin No. | Pin Name         |
|---------|------------------|---------|------------------|---------|------------------|---------|------------------|
|         |                  | -       |                  | _       |                  |         |                  |
| 1       | SI               | 21      | EV <sub>DD</sub> | 41      | HD0              | 61      | TCK              |
| 2       | NC               | 22      | GND              | 42      | GND              | 62      | I.C.             |
| 3       | SIEN/MCLK        | 23      | HD13             | 43      | EVDD             | 63      | TDI              |
| 4       | SCK/BCLK         | 24      | HD12             | 44      | HRE              | 64      | TMS              |
| 5       | so               | 25      | HD11             | 45      | HWE              | 65      | TRST             |
| 6       | SOEN/LRCLK       | 26      | HD10             | 46      | HCS              | 66      | RESET            |
| 7       | P7/PLL3          | 27      | HD9              | 47      | HRD              | 67      | INT4             |
| 8       | GND              | 28      | HD8              | 48      | HWR              | 68      | INT3             |
| 9       | P6/PLL2          | 29      | HD7              | 49      | CLKOUT           | 69      | INT2             |
| 10      | P5/PLL1          | 30      | EV <sub>DD</sub> | 50      | CLKIN            | 70      | INT1             |
| 11      | P4/PLL0          | 31      | GND              | 51      | EV <sub>DD</sub> | 71      | WAKEUP           |
| 12      | EV <sub>DD</sub> | 32      | HD6              | 52      | GND              | 72      | IV <sub>DD</sub> |
| 13      | P3               | 33      | HD5              | 53      | IVdd             | 73      | GND              |
| 14      | P2               | 34      | HD4              | 54      | GND              | 74      | SDCLK            |
| 15      | P1               | 35      | HD3              | 55      | HA0              | 75      | EV <sub>DD</sub> |
| 16      | P0               | 36      | HD2              | 56      | HA1              | 76      | GND              |
| 17      | HD15             | 37      | IVDD             | 57      | TDO              | 77      | SDCR             |
| 18      | GND              | 38      | GND              | 58      | I.C.             | 78      | NC               |
| 19      | NC               | 39      | I.C.             | 59      | I.C.             | 79      | SDDAT            |
| 20      | HD14             | 40      | HD1              | 60      | TICE             | 80      | EVDD             |

#### PIN NAME

CLKIN : Clock Input CLKOUT : Clock Output

EV<sub>DD</sub> : Power Supply for I/O Pins

GND : Ground

HA0, HA1 : Host Data Access

HCS : Host Chip Select

HD0 to HD15 : Host Data Bus

HRD : Host Read

HRE : Host Read Enable
HWE : Host Write Enable

HWR : Host Write

I.C. : Internally Connected

INT1 to INT4 : Interrupt

IVDD : Power Supply for DSP Core

NC : Non-Connection

P0 to P3 : Port

P4/PLL0 to P7/PLL3 : Port/ PLL Setting Input

RESET : Reset

SCK/BCLK : Serial Clock Input/ Output SDCLK : SD Card Clock Output

SDCR : SD Card Command Output/ Response Input

SDDAT : SD Card Data Input/ Output

SI : Serial Data Input

SIEN/MCLK : Serial Input Enable/ Master Clock Input

SO : Serial Data Output

SOEN/LRCLK : Serial Output Enable/ Left Right Clock Input/ Output

TCK : Test Clock Input
TDI : Test Data Input
TDO : Test Data Output
TICE : Test In-Circuit Emulator
TMS : Test Mode Select

TRST : Test Reset

WAKEUP : Wakeup from STOP Mode

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# 1. PIN FUNCTION

Because the pin numbers differ depending on the package, refer to the diagram of the package to be used.

# 1.1 Pin Function Description

# • Power supply

| Pin Name         | Pin No.                               |                                      | I/O | Function                   | Shared by: |
|------------------|---------------------------------------|--------------------------------------|-----|----------------------------|------------|
|                  | 80-pin FBGA                           | 80-pin TQFP                          | 1/0 | i unction                  | Shared by. |
| IV <sub>DD</sub> | A4,D7,H7                              | 37,53,72                             | -   | Power to DSP core (+2.5 V) | _          |
| EV <sub>DD</sub> | A1,A3,E8,F1,<br>G9,H2,H4              | 12,21,30,43,51,<br>75,80             | _   | Power to I/O pins (+3 V)   | -          |
| GND              | B4,C4,D9,E3,<br>E6,H1,H5,H9,<br>J2,J8 | 8,18,22,31,<br>38,42,52,54,<br>73,76 | _   | Ground                     | _          |

# System control

| Pin Name     | Pin                     | No.       | I/O        | Function  | Shared by: |
|--------------|-------------------------|-----------|------------|---|------------|
| i iii Naiile | 80-pin FBGA 80-pin TQFP |           | Shared by. |   |            |
| CLKIN        | F8                      | 50        | Input      | System clock input  | _          |
| CLKOUT       | E9                      | 49        | Output     | Internal system clock output  | _          |
| PLL0 to PLL3 | E2,D2,E1,D4             | 11,10,9,7 | Input      | PLL multiple rate setting pin  PLL3 to PLL0:  0000:x16, 0001:x1, 0010:x2, 0011:x3,  0100:x4, 0101:x5, 0110:x6, 0111:x7,  1000:x8, 1001:x9, 1010:x10, 1011:x11,  1100:x12, 1101:x13, 1110:x14,  1111:x15 | P4 to P7   |
| RESET        | A6                      | 66        | Input      | Internal system reset signal input  | _          |
| WAKEUP       | B5                      | 71        | Input      | Stop mode release signal input.  • When this pin is asserted active, the stop mode is released.   | -          |

# • Interrupt

| Pin Name      | Pin No.     |             | 1/0   | Function  | Shared by: |
|---------------|-------------|-------------|-------|---|------------|
| i iii ivaille | 80-pin FBGA | 80-pin TQFP | 1/0   | i dileton   | Shared by. |
| INT1 to INT4  | B6,A5,C5,D6 | 70,69,68,67 | Input | External maskable interrupt input.  • Detected at the falling edge. | -          |



#### Serial interface

| Pin Name   | Piı         | n No.                 | I/O            | Function   | Charad by: |
|------------|-------------|-----------------------|----------------|--|------------|
| Fill Name  | 80-pin FBGA | -pin FBGA 80-pin TQFP |                | Fullction  | Shared by: |
| SCK/BCLK   | C2          | 4                     | I/O            | Serial clock input/output SCK : Standard serial interface(input) BCLK : Audio serial interface(I/O)  | 1          |
| SOEN/LRCLK | D1          | 6                     | I/O            | Serial output enable / Left Right clock input/output SOEN: Standard serial interface(input) LRCLK: Audio serial interface(I/O)                         | I          |
| SO         | D3          | 5                     | Output<br>(3S) | Serial data output   | -          |
| SIEN/MCLK  | C1          | 3                     | Input          | Serial input enable / Master clock input<br>SIEN : Standard serial interface<br>MCLK : Audio serial interface (Master clock input<br>when master mode) | -          |
| SI         | B2          | 1                     | Input          | Serial data input  | _          |

**Remark** The pins marked "3S" under the heading "I/O" go into a high-impedance state on completion of data transfer and input of the hardware reset (RESET) signal.

#### SD card interface

| Pin Name   | Pin No.     |                         | I/O         | Function  | Shared by: |
|------------|-------------|-------------------------|-------------|---|------------|
| Tillivalle | 80-pin FBGA | 80-pin FBGA 80-pin TQFP |             | i unction   | Ghared by. |
| SDCLK      | D5          | 74                      | Output      | SD card clock output  | -          |
| SDCR       | В3          | 77                      | I/O<br>(3S) | SD card command/response Input : Response Output : Command •Leave pulled up.      | -          |
| SDDAT      | СЗ          | 79                      | I/O<br>(3S) | SD card data input/output Input : Read data Output : Write data •Leave pulled up. | _          |

**Remark** The pins marked "3S" under the heading "I/O" go into a high-impedance state when the SD card interface is not being accessed.



# • Host interface

| Pin Name    | Pin   | No.   | I/O         | Function  | Shared by:  |
|-------------|---|---|-------------|---|-------------|
| Pin Name    | 80-pin FBGA   | 80-pin TQFP   | 1/0         | Function  | Glialed by. |
| HA1         | D8  | 56  | Input       | Specifies the register to be accessed by HD15 to HD0.  1: Accesses the host interface status register (HST).  0: Accesses the host transmit data register (HDT (out)) when read (HRD = 0), and host receive data register (HDT (in)) when written (HWR = 0).            | -           |
| НАО         | C9  | 55  | Input       | Specifies the register to be accessed by HD15 to HD0.  1: Accesses bits 15 to 8 of HST, HDT (in), and HDT (out).  0: Accesses bits 7 to 0 of HST, HDT (in), and HDT (out).  When 8-bit mode, this signal becomes valid.  When 16-bit mode, this signal becomes invalid. | 1           |
| HCS         | F9  | 46  | Input       | Chip select input   | -           |
| HRD         | F6  | 47  | Input       | Host read input   | -           |
| HWR         | E7  | 48  | Input       | Host write input  | -           |
| HRE         | G8  | 44  | Output      | Host read enable output   | -           |
| HWE         | F7  | 45  | Output      | Host write enable output  | -           |
| HD0 to HD15 | H8,G7,H6,J7,<br>F5,G6,J6,J5,<br>G5,F4,J4,G4,<br>H3,J3,G3,G2 | 41,40,36,35,<br>34,33,32,29,<br>28,27,26,25,<br>24,23,20,17 | I/O<br>(3S) | 16-bit host data bus  | -           |

**Remark** The pins marked "3S" under the heading "I/O" go into a high-impedance state when the host interface is not being accessed.

# • I/O ports

| Pin Name  | Pin No.     |             | I/O  | Function                 | Shared by: |
|-----------|-------------|-------------|------|--------------------------|------------|
| Fill Name | 80-pin FBGA | 80-pin TQFP | 1,70 | Tunction                 | Shareu by. |
| P0        | F2          | 16          | I/O  | General-purpose I/O port | -          |
| P1        | G1          | 15          | I/O  |                          | -          |
| P2        | E4          | 14          | I/O  |                          | -          |
| P3        | F3          | 13          | I/O  |                          | -          |
| P4        | E2          | 11          | I/O  |                          | PLL0       |
| P5        | D2          | 10          | I/O  |                          | PLL1       |
| P6        | E1          | 9           | I/O  |                          | PLL2       |
| P7        | D4          | 7           | I/O  |                          | PLL3       |



# • Debugging interface

| Pin Name  | Pin No.     |             | 1/0    | Function      | Shared by: |  |
|-----------|-------------|-------------|--------|---------------|------------|--|
| Fill Name | 80-pin FBGA | 80-pin TQFP | 1/0    | runction      | Shared by. |  |
| TDO       | C8          | 57          | Output | For debugging | _          |  |
| TICE      | C7          | 60          | Output |               | _          |  |
| TCK       | B8          | 61          | Input  |               | _          |  |
| TDI       | A7          | 63          | Input  |               | _          |  |
| TMS       | B7          | 64          | Input  |               | _          |  |
| TRST      | C6          | 65          | Input  |               | _          |  |

# • Others

| Pin Name   | Pin         | No.         | I/O | Function  | Shared by: |  |
|------------|-------------|-------------|-----|---|------------|--|
| Tillivalle | 80-pin FBGA | 80-pin TQFP | 1/0 | i dileton   | Ghared by. |  |
| I.C.       | A8,A9,B9,J9 | 39,58,59,62 | -   | Internally connected. Leave this pin unconnected. | -          |  |
| NC         | A2,B1,J1    | 2,19,78     | ı   | No-connect pins. Leave these pins unconnected.    | ı          |  |

Caution If any signal is input to these pins or if an attempt is made to read these pins, the normal operation of the  $\mu$ PD77115 is not guaranteed.



# 1.2 Connection of Unused Pins

# 1.2.1 Connection of function pins

When mounting, connect unused pins as follows:

| Pin                         | I/O    | Recommended Connection  |
|-----------------------------|--------|---|
| INT1 to INT4                | Input  | Connect to EV <sub>DD</sub> .   |
| SCK/BCLK                    | I/O    | Connect to EV <sub>DD</sub> or GND.   |
| SI                          | Input  |   |
| SIEN/MCLK                   | Input  | Connect to GND.   |
| SOEN/LRCLK                  | I/O    |   |
| SO                          | Output | Leave unconnected   |
| SDCLK                       | Output |   |
| SDCR                        | I/O    | Connect to EV <sub>DD</sub> via pull-up resistor, or connect to GND via pull-down resistor. |
| SDDAT                       | I/O    |   |
| HA0, HA1                    | Input  | Connect to EV <sub>DD</sub> or GND.   |
| HCS, HRD, HWR               | Input  | Connect to EV <sub>DD</sub> .   |
| HRE, HWE                    | Output | Leave unconnected.  |
| HD0 to HD15 <sup>Note</sup> | I/O    | Connect to EV <sub>DD</sub> via pull-up resistor, or connect to GND via pull-down resistor. |
| P0 to P3                    | I/O    |   |
| TCK                         | Input  | Connect to GND via pull-down resistor.  |
| TDO, TICE                   | Output | Leave unconnected.  |
| TMS, TDI                    | Input  | Leave unconnected. (internally pulled up).  |
| TRST                        | Input  | Leave unconnected. (internally pulled down).  |
| CLKOUT                      | Output | Leave unconnected.  |
| WAKEUP                      | Input  | Connect to EV <sub>DD</sub> .   |

Note These pins may be left unconnected if HCS, HRD, and HWR are fixed to the high level.

However, connect these pins as recommended in the halt and stop modes when the power consumption must be lowered.

#### 1.2.2 Connection of no-function pins

| Pin  | I/O | Recommended Connection |
|------|-----|------------------------|
| I.C. | -   | Leave unconnected.     |
| NC   | -   | Leave unconnected.     |



#### 2. FUNCTION OUTLINE

# 2.1 Program Control Unit

This unit is used to execute instructions, and control branching, loops, interrupts, the clock, and the standby mode of the DSP.

#### 2.1.1 CPU control

A three-stage pipeline architecture is employed and almost all the instructions, except some instructions such as branch instructions, are executed in one system clock.

#### 2.1.2 Interrupt control

Interrupt requests input from external pins ( $\overline{\text{INT1}}$  to  $\overline{\text{INT4}}$ ) or generated by the internal peripherals (serial interface and host interface) are serviced. The interrupt of each interrupt source can be enabled or disabled. Multiple interrupts are also supported.

#### 2.1.3 Loop control task

A loop function without any hardware overhead is provided. A loop stack with four levels is provided to support multiple loops.

#### 2.1.4 PC stack

A 15-level PC stack that stores the program counter supports multiple interrupts and subroutine calls.

#### 2.1.5 PLL

A PLL is provided as a clock generator that can multiply an external clock input to supply an operating clock to the DSP. A multiple of  $\times 1$  to  $\times 16$  can be set by pins(PLL0 to PLL3).

Two standby modes are available for lowering the power consumption while the DSP is not in use.

- HALT mode: Set by execution of the HALT instruction. The current consumption drops to several mA. The normal operation mode is recovered by an interrupt or hardware reset.
- STOP mode: Set by execution of the STOP instruction. The current consumption drops to several 10  $\mu$ A. The normal operation mode is recovered by hardware reset or  $\overline{\text{WAKEUP}}$  pin.

#### 2.1.6 Instruction memory

64 words of the instruction RAM are allocated to interrupt vectors.

A boot-up ROM that boots up the instruction RAM is provided, and the instruction RAM can be initialized or rewritten by host boot (boot via host interface).

The  $\mu$ PD77115 has 11.5K-word instruction RAM.

#### 2.2 Arithmetic Unit

This unit performs multiplication, addition, logical operations, and shift, and consists of a 40-bit multiply accumulator, 40-bit data ALU, 40-bit barrel shifter, and eight 40-bit general-purpose registers.

#### 2.2.1 General-purpose registers (R0 to R7)

These eight 40-bit registers are used to input/output data for arithmetic operations, and load or store data from/to data memory.

A general-purpose register (R0 to R7) is made up of three parts: R0L to R7L (bits 15 to 0), R0H to R7H (bits 31 to 16), and R0E to R7E (bits 39 to 32). Depending on the type of operation, RnL, RnH, and RnE are used as one register or in different combinations.

#### 2.2.2 Multiply accumulator (MAC)

The MAC multiplies two 16-bit values, and adds or subtracts the multiplication result from one 40-bit value, and outputs a 40-bit value.

The MAC is provided with a shifter (MSFT: MAC ShiFTer) at the stage preceding the input stage. This shifter can arithmetically shift the 40-bit value to be added to or subtracted from the multiplication result 1 or 16 bits to the right.

#### 2.2.3 Arithmetic logic unit (ALU)

This unit inputs one or two 40-bit values, executes an arithmetic or logical operation, and outputs a 40-bit value.

#### 2.2.4 Barrel shifter (BSFT: Barrel ShiFTer)

The barrel shifter inputs a 40-bit value, shifts it to the left or right by any number of bits, and outputs a 40-bit value. The data may be arithmetically shifted to the right shifted to the right, in which case the data is sign-extended, or logically shifted to the right, in which case 0 is inserted from the MSB.



#### 2.3 Data Memory Unit

The data memory unit consists of two banks of data memory and two data addressing units.

#### 2.3.1 Data memory

The DSP have two banks of data memory (X data memory and Y data memory). A 64-word peripheral area is assigned in the data memory space.

The  $\mu$ PD77115 has 16K words × 2 banks data RAM.

#### 2.3.2 Data addressing unit

An independent data addressing unit is provided for each of the X data memory and Y data memory spaces.

Each data addressing unit has four data pointers (DPn), four index registers (DNn), one modulo register (DMX or DMY), and an address ALU.

#### 2.4 Peripheral Unit

A serial interface, host interface, general-purpose I/O port, and wait cycle register are provided. All these internal peripherals are mapped to the X data memory and Y data memory spaces, and are accessed from program as memory-mapped I/Os.

#### 2.4.1 Audio Serial interface (ASIO)

One serial interface is provided. This serial interface has two mode which are the audio serial and the standard serial. The standard serial is compatible other  $\mu$ PD77111 family DSP.

The audio serial interfaces have the following features:

· Mode: Master mode or Slave mode

Master mode: MCLK (input), BCLK (output), LRCLK (output), support 256 fs, 384 fs and 512 fs

Slave mode : MCLK (unused), BCLK (input), LRCLK (input)

• Frame format : 32 or 64 bits audio format (LRCLK format), MSB first input/output.

Handshake : Handshaking with the external devices is implemented with a dedicated frame signal (LRCLK).

Handshaking with the internal units, polling, wait, or interrupt are used.

The standard serial interfaces have the following features:

• Serial clock : Supplied from external source to each interface. The same clock is used for input and output

on the interface.

• Frame length : 8 or 16 bits, and MSB or LSB first selectable for each input or output

Handshake : Handshaking with external devices is implemented with a dedicated status signal. With the

internal units, polling, wait, or interrupt are used.

# 2.4.2 Host interface (HIO)

This is an 16-bit parallel port that inputs data from or outputs data to an external host CPU or DMA controller. In the DSP, a 16-bit register is mapped to memory for input data, output data, and status. Handshaking with an external device is implemented by using a dedicated status signal or a dedicated status register. Handshaking with internal units is achieved by means of polling, wait, or interrupts.

#### 2.4.3 General-purpose I/O port (PIO)

This is a 8-bit I/O port that can be set in the input or output mode in 1-bit units.

#### 2.4.4 SD card interface (SDCIF)

This interface is for access SD card. It supports the DMA transfer for input data to internal data RAM. The SD card is accessed by using a dedicated routine of system ROM.

#### 2.4.5 Timer

This is 16-bit timer unit. The count source can be selected from system clock, SD card clock, serial clock and INT4 input. Timer unit generates interrupt for interface internal units.

#### 3. RESET FUNCTION

When a low level of a specified width is input to the RESET pin, the device is initialized.

#### 3.1 Hardware Reset

If the RESET pin is asserted active (low level) for a specified period, the internal circuitry of the DSP is initialized. If the RESET pin is then deasserted inactive (high level), boot processing of the instruction RAM is performed according to the status of the port pins (P0 and P1). After boot processing, processing is executed starting from the instruction at address 0x200 of instruction memory (reset entry).

No power-ON reset function is available.

#### 3.2 Initializing PLL

Initializing the PLL starts during boot up program at reset. The pins (PLL0 to PLL3) that specify the PLL multiple rate must be kept stable for the duration of 3 clocks before and for the duration of 50 clocks after reset has been cleared (the clock is input from CLKIN). It takes the PLL 100  $\mu$ s to be locked. Until the PLL is lacked, the DSP internal is operated by the CLKIN clock.

To use the PLL clock as an internal operating clock, set the clock control register (internal peripheral) by user program.

#### 4. FUNCTIONS OF BOOT-UP ROM

To rewrite the contents of the instruction memory on power application or from program, boot up the instruction RAM by using the internal boot-up ROM.

The  $\mu$ PD77115 has a function to verify the contents of the internal instruction RAM.

#### 4.1 Boot at Reset

After hardware reset has been cleared, the boot program first reads the general-purpose I/O ports P0 and P1 and, depending on their bit pattern, determines the boot mode (host boot or non boot). After boot processing, processing is executed starting from the instruction at address 0x200 (reset entry) of the instruction memory.

The pins (P0 and P1) that specify the boot mode must be kept stable for the duration of 3 clocks before and for the duration of 12 clocks after reset has been cleared (the clock is input from CLKIN).



| P1 | P0 | Boot Mode   |
|----|----|---|
| 0  | 0  | Does not execute boot but branches to address 0x200 <sup>Note</sup> . |
| 0  | 1  | Executes host byte boot and then branches to address 0x200.           |
| 1  | 0  | Setting prohibited  |
| 1  | 1  | Executes host word boot and then branches to address 0x200.           |

**Note** This setting is used when the DSP must be reset to recover from the standby mode after reset boot has been executed once.

A boot parameter and instruction code are obtained via the host interface, and transferred to the instruction RAM. The data transfer support byte mode and word mode.

#### 4.2 Reboot

By calling the reboot entry address from the program, the contents of the instruction RAM can be rewritten. An instruction code is obtained via the host interface and transferred to the instruction RAM. The data transfer support byte mode and word mode.

The entry address is 0x6. Host reboot is executed by calling this address after setting the following parameter:

- · R7L: Number of instruction steps for rebooting
- DP3: First address of instruction memory to be loaded

### 4.3 Signature Operation

The  $\mu$ PD77115 has a signature operation function so that the contents of the internal instruction RAM can be verified. The signature operation performs a specific arithmetic operation on the data in the instruction RAM booted up, and returns the result to a register. Perform the signature operation in advance on the device when it is operating normally, and repeat the signature operation later to check whether the data in RAM is correct by comparing the operation result with the previous result. If the results are identical, there is no problem.

The entry address is 0x9. Execute the operation by calling this address after setting the following parameter. The operation result is stored in register R7.

- R7L: Number of instruction steps for operation
- DP3: First address of instruction memory for operation

#### 5. STANDBY MODES

Two standby modes are available. By executing the corresponding instruction, each mode is set and the power consumption can be reduced.

#### 5.1 HALT Mode

To set this mode, execute the HALT instruction. In this mode, functions other than clock circuit and PLL are stopped to reduce the current consumption.

To release the HALT mode, use an interrupt or hardware reset. When releasing the HALT mode using an interrupt, the contents of the internal registers and memory are retained. It takes several 10 system clocks to release the HALT mode when the HALT mode is released using an interrupt.

In the HALT Mode, the clock circuit of the  $\mu$ PD77115 supplies the following clock as the internal system clock. The clock output from the CLKOUT pin is also as follows.

The clock output from the CLKOUT pin, however, has a high-level width that is equivalent to 1 cycle of the normal operation (i.e., the duty factor is not 50%).

•  $\mu$ PD77115: 1/I of internal system clock (I = integer from 1 to 16, specified by register)

#### 5.2 STOP Mode

To set the STOP mode, execute the STOP instruction. In the STOP mode, all the functions, including the clock circuit and PLL, can be stopped and the power consumption is minimized with only leakage current flowing.

To release the STOP mode, use hardware reset or WAKEUP pin.

When releasing the STOP mode by using the WAKEUP pin, the contents of the internal registers and memory are retained, but it takes several 100  $\mu$ s to release the mode.

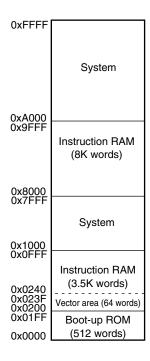


#### 6. MEMORY MAP

A Harvard architecture, in which the instruction memory space and data memory space are separated is employed.

# 6.1 Instruction Memory

#### **★** 6.1.1 Instruction memory map



Caution Programs and data cannot be placed at addresses reserved for the system, nor can these addresses be accessed. If these addresses are accessed, the normal operation of the device cannot be guaranteed.

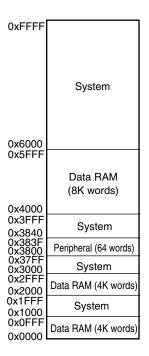
# 6.1.2 Interrupt vector table

Addresses 0x200 to 0x23F of the instruction memory are entry points (vectors) of interrupts. Four instruction addresses are assigned to each interrupt source.

| Vector | Interrupt Source  |
|--------|-------------------|
| 0x200  | Reset             |
| 0x204  | Reserved          |
| 0x208  |                   |
| 0x20C  |                   |
| 0x210  | INT1              |
| 0x214  | INT2              |
| 0x218  | INT3              |
| 0x21C  | INT4              |
| 0x220  | SI input          |
| 0x224  | SO output         |
| 0x228  | SDDAT input / PBU |
| 0x22C  | SDDAT output      |
| 0x230  | HI input          |
| 0x234  | HO output         |
| 0x238  | SDCR input        |
| 0x23C  | Timer             |

- Cautions 1. Although reset is not an interrupt, it is handled like an interrupt as an entry to a vector.
  - 2. It is recommended that unused interrupt source vectors be used to branch an error processing routine.

- 6.2 Data Memory
- 6.2.1 Data memory map



Caution Programs and data cannot be placed at addresses reserved for the system, nor can these addresses be accessed. If these addresses are accessed, the normal operation of the device cannot be guaranteed.



# 6.2.2 Internal peripherals

The internal peripherals are mapped to the internal data memory space.

| X/Y Memory Address | Register Name | Function                               | Peripheral Name |
|--------------------|---------------|--|-----------------|
| 0x3800             | SDT/ASDT      | Serial data register                   | ASIO            |
| 0x3801             | SST           | Serial status register                 |                 |
| 0x3802             | ASST          | Audio serial status register           |                 |
| 0x3803             | Reserved area | Caution Do not access this area.       | -               |
| 0x3804             | PDT           | Port data register                     | PIO             |
| 0x3805             | PCD           | Port command register                  |                 |
| 0x3806             | HDT           | Host data register                     | HIO             |
| 0x3807             | HST           | Host status register                   |                 |
| 0x3808 to 0x380F   | Reserved area | Caution Do not access this area.       | -               |
| 0x3810             | SDDR          | SD card data register                  | SDCIF           |
| 0x3811             | SDCMD_IDX     | SD card command register index         |                 |
| 0x3812             | SDCMD_AGH     | SD card command register argument high |                 |
| 0x3813             | SDCMD_AGL     | SD card command register argument low  |                 |
| 0x3814             | SDCTL         | SD card control register               |                 |
| 0x3815             | SDRPR         | SD card response register              |                 |
| 0x3816             | SDSBR         | SD card CRC status busy register       |                 |
| 0x3817 to 0x381F   | Reserved area | Caution Do not access this area.       | -               |
| 0x3820             | TIR           | Timer initialize value register        | Timer           |
| 0x3821             | TCR           | Timer count register                   |                 |
| 0x3822             | TCSR          | Timer control / status register        |                 |
| 0x3823             | TENR          | Timer count enable register            |                 |
| 0x3824 to 0x382D   | Reserved area | Caution Do not access this area.       | -               |
| 0x382E             | CLKCNTL       | Clock control register                 | PLL             |
| 0x382F             | Reserved area | Caution Do not access this area.       | _               |
| 0x3830             | PSAR          | DMA start address register             | SDCIF           |
| 0x3831             | PSR           | DMA size register                      |                 |
| 0x3832             | PRR           | DMA pointer register                   |                 |
| 0x3833             | PCR           | DMA control register                   |                 |
| 0x3834 to 0x383F   | Reserved area | Caution Do not access this area.       | _               |

- Cautions 1. The register names listed in this table are not reserved words of the assembler or the C language. Therefore, when using these names in assembler or C, the user must define them.
  - 2. The same register is accessed, as long as the address is the same, regardless of whether the X memory space or Y memory space is accessed.
  - 3. Even different registers cannot be accessed at the same time from both the X and Y memory spaces.



#### 7. INSTRUCTIONS

#### 7.1 Outline of Instructions

An instruction consists of 32 bits. Almost all the instructions, except some such as branch instructions, are executed with one system clock. The maximum instruction cycle of the  $\mu$ PD77115 is 13.3 ns. The following nine types of instructions are available:

#### (1) Trinomial operation instructions

These instructions specify an operation by the MAC. As the operands, three general-purpose registers can be specified.

#### (2) Binomial operation instructions

These instructions specify an operation by the MAC, ALU, or BSFT. As the operands, two general-purpose registers can be specified. An immediate value can be specified for some of these instructions, instead of a general-purpose register, for one input.

#### (3) Uninominal operation instructions

These instructions specify an operation by the ALU. As the operands, one general-purpose register can be specified.

#### (4) Load/store instructions

These instructions transfer 16-bit values between memory and a general-purpose register. Any general-purpose register can be specified as the transfer source or destination.

#### (5) Register-to-register transfer instructions

These instructions transfer data from one general-purpose register to another.

### (6) Immediate value setting instructions

These instructions write an immediate value to a general-purpose register and the registers of the address operation unit.

#### (7) Branch instructions

These instruction specify branching of program execution.

#### (8) Hardware loop instructions

These instruction specify repetitive execution of an instruction.

#### (9) Control instructions

These instructions are used to control the program.



# 7.2 Instruction Set and Operation

An operation is written in the operation field for each instruction in accordance with the operation representation format of that instruction. If two or more parameters can be written, select one of them.

# (a) Representation formats and selectable registers

The following table shows the representation formats and selectable registers.

| Representation Format | Selectable Register   |
|-----------------------|---|
| r0, r0', r0"          | R0 to R7  |
| rl, rl'               | R0L to R7L  |
| rh, rh'               | R0H to R7H  |
| re                    | R0E to R7E  |
| reh                   | R0EH to R7EH  |
| dp                    | DP0 to DP7  |
| dn                    | DN0 to DN7  |
| dm                    | DMX, DMY  |
| dpx                   | DP0 to DP3  |
| dpy                   | DP4 to DP7  |
| dpx_mod               | DPn, DPn++, DPn, DPn##, DPn%%, !DPn## (n = 0 to 3)  |
| dpy_mod               | DPn, DPn++, DPn, DPn##, DPn%%, !DPn## (n = 4 to 7)  |
| dp_imm                | DPn##imm (n = 0 to 7)   |
| *xxx                  | Contents of memory with address xxx<br><example> If the contents of the DP0 register are 1000, *DP0 indicates the contents of address 1000 of the memory.</example> |



#### (b) Modifying data pointer

The data pointer is modified after the memory has been accessed. The result of modification becomes valid starting from the instruction that immediately follows. The data pointer cannot be modified.

| Example  | Operation  |
|----------|--|
| DPn      | Nothing is done (value of DPn is not changed.)   |
| DPn++    | DPn ← DPn + 1  |
| DPn      | DPn ← DPn − 1  |
| DPn##    | DPn ← DPn + DNn  (Adds value of corresponding DN0 to DN7 to DP0 to DP7.)  Example: DP0 ← DP0 + DN0 |
| DPn%%    | (n = 0 to 3) DPn = ((DPL + DNn) mod (DMX + 1)) + DPH   |
|          | (n = 4 to 7) DPn = ((DPL + DNn) mod (DMY + 1)) + DPH   |
| !DPn##   | Reverses bits of DPn and then accesses memory.  After memory access, DPn ← DPn + DNn               |
| DPn##imm | DPn ← DPn + imm  |

# (c) Instructions that can be simultaneously written

Instructions that can be simultaneously written are indicated by O.

#### (d) Status of overflow flag (OV)

The status of the overflow flag is indicated by the following symbol:

- •: Not affected
- ‡: Set to 1 when overflow occurs

Caution If an overflow does not occur as a result of an operation, the overflow flag is not reset but retains the status before the operation.



# **Instruction Set**

|                     |                                  |  |  | Instructions Simultaneously Written |               |                 |                |               |                         |             |      |              |    |
|---------------------|----------------------------------|--|--|-------------------------------------|---------------|-----------------|----------------|---------------|-------------------------|-------------|------|--------------|----|
| Instruc-<br>tion    | Instruction<br>Name              | Mnemonic   | Operation  | Trino-<br>mial                      | Bino-<br>mial | Unino-<br>minal | Load/<br>store | Trans-<br>fer | Imme-<br>diate<br>value | Bran-<br>ch | Loop | Cont-<br>rol | ov |
| Trinomial operation | Multiply add                     | ro = ro + rh * rh'   | $ro \leftarrow ro + rh * rh'$                      |                                     |               |                 | √              |               |                         |             |      |              | ‡  |
|                     | Multiply sub                     | ro = ro - rh * rh'   | $ro \leftarrow ro - rh * rh'$                      |                                     |               |                 | √              |               |                         |             |      |              | ‡  |
|                     | Sign unsign<br>multiply add      | ro = ro + rh * rl<br>(rl is in positive integer<br>format.)              | ro ← ro + rh * rl                                  |                                     |               |                 | √              |               |                         |             |      |              | ‡  |
|                     | Unsign unsign<br>multiply add    | ro = ro + rl * rl'<br>(rl and rl' are in<br>positive integer<br>format.) | ro ← ro + rl * rl'                                 |                                     |               |                 | V              |               |                         |             |      |              | ‡  |
|                     | 1-bit shift multiply add         | ro = (ro>>1) + rh * rh'  | $ro \leftarrow \frac{ro}{2} + rh * rh'$            |                                     |               |                 | √              |               |                         |             |      |              | ‡  |
|                     | 16-bit shift multiply add        | ro = (ro>>16) + rh * rh'   | $ro \leftarrow \frac{ro}{2^{16}} + rh * rh'$       |                                     |               |                 | 1              |               |                         |             |      |              | •  |
| Binomial            | Multiply                         | ro = rh * rh'  | ro ← rh * rh'                                      |                                     |               |                 | V              |               |                         |             |      |              | •  |
| operation           | Add                              | ro" = ro + ro'   | $ro$ " $\leftarrow$ $ro$ + $ro$ '                  |                                     |               |                 | <b>V</b>       |               |                         |             |      |              | ‡  |
|                     | Immediate add                    | ro' = ro + imm   | ro' ← ro + imm<br>(where imm ≠ 1)                  |                                     |               |                 |                |               |                         |             |      |              | ‡  |
|                     | Sub                              | ro" = $ro - ro$ '  | $ro$ " $\leftarrow$ $ro$ $ ro$ '                   |                                     |               |                 | <b>V</b>       |               |                         |             |      |              | ‡  |
|                     | Immediate sub                    | ro' = ro – imm   | $ro' \leftarrow ro - imm$<br>(where imm $\neq 1$ ) |                                     |               |                 |                |               |                         |             |      |              | ‡  |
|                     | Arithmetic right shift           | ro' = ro SRA rl  | ro' ← ro >> rl                                     |                                     |               |                 | 1              |               |                         |             |      |              | •  |
|                     | Immediate arithmetic right shift | ro' = ro SRA imm   | ro' ← ro >> imm                                    |                                     |               |                 |                |               |                         |             |      |              | •  |
|                     | Logical right shift              | ro' = ro SRL rl  | ro' ← ro >> rl                                     |                                     |               |                 | <b>V</b>       |               |                         |             |      |              | •  |
|                     | Immediate logical right shift    | ro' = ro SRL imm   | ro' ← ro >> imm                                    |                                     |               |                 |                |               |                         |             |      |              | •  |
|                     | Logical left shift               | ro' = ro SLL rl  | ro' ← ro << rl                                     |                                     |               |                 | √              |               |                         |             |      |              | •  |
|                     | Immediate logical left shift     | ro' = ro SLL imm   | ro' ← ro << imm                                    |                                     |               |                 |                |               |                         |             |      |              | •  |
|                     | AND                              | ro" = ro & ro'   | ro" ← ro & ro'                                     |                                     |               |                 | √              |               |                         |             |      |              | •  |
|                     | Immediate AND                    | ro' = ro & imm   | ro' ← ro & imm                                     |                                     |               |                 |                |               |                         |             |      |              | •  |
|                     | OR                               | ro" = ro   ro'   | ro" ← ro  l ro'                                    |                                     |               |                 | √              |               |                         |             |      |              | •  |
|                     | Immediate OR                     | ro' = ro   imm   | ro' ← ro   imm                                     |                                     |               |                 |                |               |                         |             |      |              | •  |
|                     | Exclusive OR                     | ro" = ro ^ ro'   | ro" ← ro ˆ ro'                                     |                                     |               |                 | <b>V</b>       |               |                         |             |      |              | •  |
|                     | Immediate exclusive OR           | ro' = ro ^ imm   | ro' ← ro ˆ imm                                     |                                     |               |                 |                |               |                         |             |      |              | •  |



|                    |                         |                    |  | Instructions Simultaneously Written |               |                 |                |               |                         |             |      |              |          |
|--------------------|-------------------------|--------------------|--|-------------------------------------|---------------|-----------------|----------------|---------------|-------------------------|-------------|------|--------------|----------|
| Instruc-<br>tion   | Instruction<br>Name     | Mnemonic           | Operation  | Trino-<br>mial                      | Bino-<br>mial | Unino-<br>minal | Load/<br>store | Trans-<br>fer | Imme-<br>diate<br>value | Bran-<br>ch | Loop | Cont-<br>rol | ov       |
| Binomial operation | Less than               | ro" = LT (ro, ro') | $ \begin{aligned} & \text{if (ro < ro')} \\ & \{ ro'' \leftarrow 0x000000001 \} \\ & \text{else } \{ ro'' \leftarrow 0x0000000000 \} \end{aligned} $   |                                     |               |                 | √              |               |                         |             |      |              | •        |
| Uninom-            | Clear                   | CLR (ro)           | ro ← 0x0000000000  |                                     |               |                 | √              |               |                         |             |      | $\sqrt{}$    | •        |
| inal operation     | Increment               | ro' = ro + 1       | ro' ← ro + 1   |                                     |               |                 | √              |               |                         |             |      | √            | ‡        |
| орогилогг          | Decrement               | ro' = ro – 1       | $ro' \leftarrow ro - 1$  |                                     |               |                 | √              |               |                         |             |      | √            | <b>‡</b> |
|                    | Absolute value          | ro' = ABS (ro)     | $ if (ro < 0) \\ \{ro' \leftarrow -ro\} \\ else \ \{ro' \leftarrow ro\} $  |                                     |               |                 | √              |               |                         |             |      | √            | ‡        |
|                    | 1's complement          | ro' = ~ro          | ro' ← ~ro  |                                     |               |                 | √              |               |                         |             |      | √            | •        |
|                    | 2's complement          | ro' = -ro          | ro' ← −ro  |                                     |               |                 | <b>V</b>       |               |                         |             |      | √            | ţ        |
|                    | Clip                    | ro' = CLIP (ro)    | $\label{eq:continuous_state} \begin{split} &\text{if ( ro > 0x007FFFFFF)} \\ &\text{ \{ro' \leftarrow 0x007FFFFFFF\}} \\ &\text{ elseif } \{ro < 0xFF80000000\} \\ &\text{ \{ro' \leftarrow 0xFF80000000\}} \\ &\text{ else } \{ro' \leftarrow ro\} \end{split}$ |                                     |               |                 | V              |               |                         |             |      | √            | •        |
|                    | Round                   | ro' = ROUND (ro)   | if (ro > 0x007FFF0000)<br>{ro' ← 0x007FFF0000}<br>elseif {ro < 0xFF80000000}<br>{ro' ← 0xFF80000000}<br>else {ro' ← (ro + 0x8000)<br>& 0xFFFFFF0000}   |                                     |               |                 | √              |               |                         |             |      | √            | •        |
|                    | Exponent                | ro' = EXP (ro)     | $ro' \leftarrow log_2(\frac{1}{ro})$   |                                     |               |                 | √              |               |                         |             |      | √            | •        |
|                    | Substitution            | ro' = ro           | ro' ← ro   |                                     |               |                 | √              |               |                         |             |      | √            | •        |
|                    | Accumulated addition    | ro' + = ro         | ro' ← ro' + ro   |                                     |               |                 | 1              |               |                         |             |      | 1            | ‡        |
|                    | Accumulated subtraction | ro' – = ro         | ro' ← ro' − ro   |                                     |               |                 | 1              |               |                         |             |      | √            | ‡        |
|                    | Division                | ro' / = ro         | if (sign (ro') == sign (ro))<br>{ro' $\leftarrow$ (ro' - ro) $<<$ 1}<br>else<br>{ro' $\leftarrow$ (ro' + ro) $<<$ 1}<br>if (sign (ro')==0)<br>{ro' $\leftarrow$ ro' $+$ 1}   |                                     |               |                 | V              |               |                         |             |      | √            | ‡        |

|                         |   |   |  | Instructions Simultaneously Written |               |                 |                |               |                         |             |      |              |    |
|-------------------------|---|---|--|-------------------------------------|---------------|-----------------|----------------|---------------|-------------------------|-------------|------|--------------|----|
| Instruc-<br>tion        | Instruction<br>Name                             | Mnemonic                                | Operation  | Trino-<br>mial                      | Bino-<br>mial | Unino-<br>minal | Load/<br>store | Trans-<br>fer | Imme-<br>diate<br>value | Bran-<br>ch | Loop | Cont-<br>rol | ov |
| Load/<br>store          | Parallel load/store Notes 1, 2                  | ro = *dpx_mod<br>ro' =*dpy_mod          | $ro \leftarrow *dpx, ro' \leftarrow *dpy$  | √                                   | 1             | √               |                |               |                         |             |      |              | •  |
|                         |   | ro = *dpx_mod<br>*dpy_mod = rh          | $ro \leftarrow *dpx, *dpy \leftarrow rh$   |                                     |               |                 |                |               |                         |             |      |              |    |
|                         |   | *dpx_mod = rh<br>ro = *dpy_mod          | *dpx $\leftarrow$ rh, ro $\leftarrow$ *dpy   |                                     |               |                 |                |               |                         |             |      |              |    |
| l I                     |   | *dpx_mod = rh<br>*dpy_mod = rh'         | *dpx $\leftarrow$ rh, *dpy $\leftarrow$ rh'  |                                     |               |                 |                |               |                         |             |      |              |    |
|                         | Partial load/<br>store <sup>Notes 1, 2, 3</sup> | dest = *dpx_mod<br>dest' = *dpy_mod     | $\begin{aligned} \text{dest} &\leftarrow \text{*dpx}, \\ \text{dest'} &\leftarrow \text{*dpy} \end{aligned}$ |                                     |               |                 |                |               |                         |             |      |              | •  |
|                         |   | dest = *dpx_mod<br>*dpy_mod = source    | dest ← *dpx,<br>*dpy ← source  |                                     |               |                 |                |               |                         |             |      |              |    |
|                         |   | *dpx_mod = source<br>dest = *dpy_mod    | *dpx ← source,<br>dest ← *dpy  |                                     |               |                 |                |               |                         |             |      |              |    |
|                         |   | *dpx_mod = source<br>*dpy_mod = source' | *dpx ← source,<br>*dpy ← source'   |                                     |               |                 |                |               |                         |             |      |              |    |
|                         | Direct  | dest = *addr                            | dest ← *addr   |                                     |               |                 |                |               |                         |             |      |              | •  |
|                         | addressing<br>load/store <sup>Note 4</sup>      | *addr = source                          | *addr ← source   |                                     |               |                 |                |               |                         |             |      |              |    |
|                         | Immediate                                       | dest = *dp_imm                          | dest ← *dp   |                                     |               |                 |                |               |                         |             |      |              | •  |
|                         | value index<br>load/store <sup>Note 5</sup>     | *dp_imm = source                        | *dp ← source   |                                     |               |                 |                |               |                         |             |      |              |    |
| Register-               | Register-to-                                    | dest = rl                               | dest ← rl  |                                     |               |                 |                |               |                         |             |      | √            | •  |
| to-register<br>transfer | register<br>transfer <sup>Note 6</sup>          | rl = source                             | rl ← source  |                                     |               |                 |                |               |                         |             |      |              |    |
| Immediate value         | Immediate value setting                         | rI = imm<br>(where imm = 0 to 0xFFFF)   | rl ← imm   |                                     |               |                 |                |               |                         |             |      |              | •  |
| setting                 |   | dp = imm<br>(where imm = 0 to 0xFFFF)   | dp ← imm   |                                     |               |                 |                |               |                         |             |      |              |    |
|                         |   | dn = imm<br>(where imm = 0 to 0xFFFF)   | dn ← imm   |                                     |               |                 |                |               |                         |             |      |              |    |
|                         |   | dm = imm<br>(where imm = 1 to 0xFFFF)   | dm ← imm   |                                     |               |                 |                |               |                         |             |      |              |    |

**Notes 1.** Of the two mnemonics, either one of them or both can be written.

- 2. After transfer, modification specified by mod is performed.
- **3.** Select any of dest, dest' = {ro, reh, re, rh, rl}, source, source' = {re, rh, rl}.
- 4. Select any of dest = {ro, reh, re, rh, rl}, source = {re, rh, rl}, addr = {0: X-0xFFF : X (X memory)} 0: Y-0xFFFF: Y (Y memory)}
- 5. Select any of dest =  $\{ro, reh, re, rh, rl\}$ , source =  $\{re, rh, rl\}$ .
- **6.** Select any register other than general-purpose registers as dest and source.



|                       |                                   |   |  | Instructions Simultaneously Written |               |                 |                |               |                         |             |      |          |    |
|-----------------------|-----------------------------------|---|--|-------------------------------------|---------------|-----------------|----------------|---------------|-------------------------|-------------|------|----------|----|
| Instruc-<br>tion      | Instruction<br>Name               | Mnemonic  | Operation  | Trino-<br>mial                      | Bino-<br>mial | Unino-<br>minal | Load/<br>store | Trans-<br>fer | Imme-<br>diate<br>value | Bran-<br>ch | Loop | Cont-    | ov |
| Branch                | Jump                              | JMP imm   | PC ← imm   |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Register indirect jump            | JMP dp  | PC ← dp  |                                     |               |                 |                |               |                         |             |      | √        | •  |
|                       | Subroutine call                   | CALL imm  | $SP \leftarrow SP + 1$ $STK \leftarrow PC + 1$ $PC \leftarrow imm$   |                                     |               |                 |                |               |                         |             |      | √        | •  |
|                       | Register indirect subroutine call | CALL dp   | $SP \leftarrow SP + 1$ $STK \leftarrow PC + 1$ $PC \leftarrow dp$  |                                     |               |                 |                |               |                         |             |      | √        | •  |
|                       | Return                            | RET   | $PC \leftarrow STK$ $SP \leftarrow SP - 1$   |                                     |               |                 |                |               |                         |             |      | √        | •  |
|                       | Interrupt<br>return               | RETI  | PC ← STK STK ← SP – 1 Recovery of interrupt enable flag  |                                     |               |                 |                |               |                         |             |      | <b>V</b> | •  |
| Hard-<br>ware<br>loop | Repeat                            | REP count   | $ \begin{array}{lll} \text{Start} & & \text{RC} \leftarrow \text{count} \\ & & \text{RF} \leftarrow 0 \\ \text{During repeat} & & \text{PC} \leftarrow \text{PC} \\ & & \text{RC} \leftarrow \text{RC} - 1 \\ \text{End} & & \text{PC} \leftarrow \text{PC} + 1 \\ & & & \text{RF} \leftarrow 1 \\ \end{array} $             |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Loop                              | LOOP count<br>(instruction of two or<br>more lines) | $ \begin{array}{lll} \text{Start} & & \text{RC} \leftarrow \text{count} \\ & & \text{RF} \leftarrow 0 \\ & \text{During repeat} & & \text{PC} \leftarrow \text{PC} \\ & & & \text{RC} \leftarrow \text{RC} - 1 \\ & & & \text{End} & & \text{PC} \leftarrow \text{PC} + 1 \\ & & & & \text{RF} \leftarrow 1 \\ \end{array} $ |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Loop pop                          | LPOP  | $LC \leftarrow LSR3$ $LE \leftarrow LSR2$ $LS \leftarrow LSR1$ $LSP \leftarrow LSP - 1$  |                                     |               |                 |                |               |                         |             |      |          | •  |
| Control               | No operation                      | NOP   | PC ← PC + 1  |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Halt                              | HALT  | CPU stops.   |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Stop                              | STOP  | CPU, PLL, and<br>OSC stop  |                                     |               |                 |                |               |                         |             |      |          | •  |
|                       | Condition                         | IF (ro cond)  | Condition test   |                                     |               | √               |                | √             |                         | √           |      |          | •  |
|                       | Forget interrupt                  | FINT  | Discard interrupt request  |                                     |               |                 |                |               |                         |             |      |          | •  |

# 8. ELECTRICAL SPECIFICATIONS

# Absolute Maximum Ratings ( $T_A = +25$ °C)

| Parameter                     | Symbol           | Condition         | Rating       | Unit |
|-------------------------------|------------------|-------------------|--------------|------|
| Supply voltage                | IV <sub>DD</sub> | For DSP core      | −0.5 to +3.6 | V    |
|                               | EV <sub>DD</sub> | For I/O pins      | -0.5 to +4.6 | V    |
| Input voltage                 | Vı               | VI < EVDD + 0.5 V | −0.5 to +4.1 | V    |
| Output voltage                | Vo               |                   | -0.5 to +4.1 | V    |
| Storage temperature           | T <sub>stg</sub> |                   | -65 to +150  | °C   |
| Operating ambient temperature | Та               |                   | -40 to +85   | °C   |

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

#### **Recommended Operating Conditions**

| Parameter         | Symbol           | Condition    | MIN. | TYP. | MAX.             | Unit |
|-------------------|------------------|--------------|------|------|------------------|------|
| Operating voltage | IV <sub>DD</sub> | For DSP core | 2.0  |      | 2.7              | V    |
|                   | EV <sub>DD</sub> | For I/O pins | 2.7  |      | 3.6              | V    |
| Input voltage     | Vı               |              | 0    |      | EV <sub>DD</sub> | V    |

# Capacitance ( $T_A = +25^{\circ}C$ , $IV_{DD} = 0 V$ , $EV_{DD} = 0 V$ )

| Parameter          | Symbol | Condition                         | MIN. | TYP. | MAX. | Unit |
|--------------------|--------|-----------------------------------|------|------|------|------|
| Input capacitance  | Сі     | f = 1 MHz,                        |      | 10   |      | pF   |
| Output capacitance | Co     | Pins other than those tested: 0 V |      | 10   |      | pF   |
| I/O capacitance    | Сю     | icsicu. o v                       |      | 10   |      | pF   |



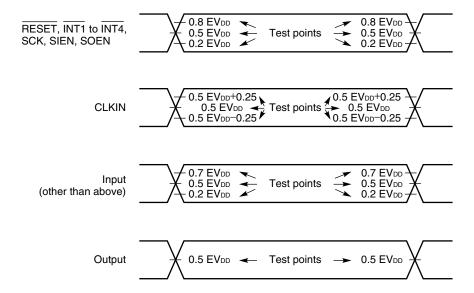
# DC Characteristics (Unless otherwise specified, $T_A = -40$ to +85°C, with IVDD and EVDD within recommended operating condition range)

| Parameter   | Symbol              | Condition   | MIN. TYP.                     |     | MAX.                          | Unit |
|---|---------------------|---|-------------------------------|-----|-------------------------------|------|
| High-level input voltage  | VIHN                | Pins other than below   | 0.7 EV <sub>DD</sub>          |     | EV <sub>DD</sub>              | V    |
|   | Vihs                | RESET, INT1 to INT4,<br>SCK, SIEN, SOEN   | 0.8 EV <sub>DD</sub>          |     | EV <sub>DD</sub>              | V    |
|   | VIHC                | CLKIN   | 0.5 EV <sub>DD</sub><br>+0.25 |     | EV <sub>DD</sub>              | V    |
| Low-level input voltage   | VIL                 | Pins other than below   | 0                             |     | 0.2 EV <sub>DD</sub>          | V    |
|   | Vic                 | CLKIN   | 0                             |     | 0.5 EV <sub>DD</sub><br>-0.25 | V    |
| High-level output voltage   | Vон                 | lон = −2.0 mA   | 0.7 EV <sub>DD</sub>          |     |                               | V    |
|   |                     | Ioн = −100 μA   | 0.8 EV <sub>DD</sub>          |     |                               | V    |
| Low-level output voltage  | Vol                 | IoL = 2.0 mA  |                               |     | 0.2 EV <sub>DD</sub>          | V    |
| High-level input leakage current  | Існ                 | Other than TDI, TMS, and TRST V <sub>I</sub> = EV <sub>DD</sub>                   | 0                             |     | 10                            | μΑ   |
| Low-level input leakage current   | lıı                 | Other than TDI, TMS, and TRST V <sub>I</sub> = 0 V                                | -10                           |     | 0                             | μΑ   |
| Pull-up pin current   | <b>I</b> PUI        | TDI, TMS, 0 V $\leq$ V <sub>I</sub> $\leq$ EV <sub>DD</sub>                       | -250                          |     | 0                             | μΑ   |
| Pull-down pin current   | <b>I</b> PDI        | $\overline{TRST}$ , 0 V $\leq$ V <sub>I</sub> $\leq$ EV <sub>DD</sub>             | 0                             |     | 250                           | μΑ   |
| Internal supply current $ [V_{IHN} = V_{IHS} = EV_{DD}, \ V_{IL} = 0 \ V, \\ no \ load] $ | IDD <sup>Note</sup> | During operating, 30 ns, IV <sub>DD</sub> = 2.7 V                                 |                               | TBD | 75                            | mA   |
|   | Іррн                | In halt mode, t <sub>CC</sub> = 30 ns, divided by eight, IV <sub>DD</sub> = 2.7 V |                               | TBD | 10                            | mA   |
|   | IDDS                | In stop mode, 0°C < T <sub>A</sub> < 60°C   |                               |     | 100                           | μΑ   |

**Note** The TYP. values are when an ordinary program is executed.

The MAX. values are when a special program that brings about frequent switching inside the device is executed.

# **Common Test Criteria of Switching Characteristics**





AC Characteristics (T<sub>A</sub> = -40 to +85°C, with IV<sub>DD</sub> and EV<sub>DD</sub> within recommended operating condition range)

# Clock

# **Timing requirements**

\*

| Parameter                          | Symbol  | Condition                        |                                    | MIN.   | TYP. | MAX.   | Unit |
|------------------------------------|---------|----------------------------------|------------------------------------|--------|------|--------|------|
| CLKIN cycle time <sup>Note 1</sup> | t₀cx    |                                  |                                    | 25     |      |        | ns   |
|                                    |         | PLL lock range <sup>Note 2</sup> | IV <sub>DD</sub> = 2.0<br>to 2.7 V | 15 × m |      | 50 × m | ns   |
|                                    |         |                                  | IV <sub>DD</sub> = 2.3<br>to 2.7 V | 10 × m |      | 50 × m | ns   |
| CLKIN high-level width             | twcxн   |                                  |                                    | 12.5   |      |        | ns   |
| CLKIN low-level width              | twcxL   |                                  |                                    | 12.5   |      |        | ns   |
| CLKIN rise/fall time               | tricx   |                                  |                                    |        |      | 5      | ns   |
| Internal clock cycle time          | tcC (R) | IV <sub>DD</sub> = 2.0 to 2.7 V  |                                    | 20     |      |        | ns   |
| requirements <sup>Note 3</sup>     |         | IV <sub>DD</sub> = 2.3 to 2      | .7 V                               | 13.3   |      |        | ns   |

Notes 1. m: Multiple

2. This is the range in which the PLL is locked (stably oscillates). Input tccx within this range.

3. Input  $t_{CCX}$  so that the value of  $(t_{CCX} \div m \times n)$  satisfies this condition. m: Multiple, n: Division ratio

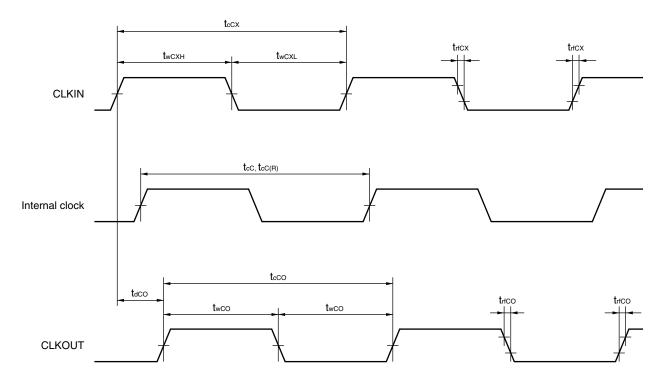
# **Switching characteristics**

| Parameter                            | Symbol        | Condition   |                       | MIN.                             | TYP.  | MAX. | Unit |    |
|--------------------------------------|---------------|---|-----------------------|----------------------------------|---|------|------|----|
| Internal clock cycle <sup>Note</sup> | tcc           | External clock operation  PLL clock operation                                       |                       |                                  | t₀cx  |      | ns   |    |
|                                      |               |   |                       |                                  | $(t_{ccx} \div m) \times n$                 |      | ns   |    |
|                                      |               | In HALT   | In HALT mode          |                                  | $(t_{\text{ccx}} \div m) \times n \times I$ |      | ns   |    |
| CLKOUT cycle time                    | t₀co          |   |                       |                                  | t₀c   |      | ns   |    |
| CLKOUT width                         | twco          | During  | n = 1, or even number | tcc ÷ 2 - 3                      |   |      | ns   |    |
|                                      |               |   | normal operation      | n = odd number<br>(other than 1) | t₀c ÷ n − 3                                 |      |      | ns |
|                                      |               | In HALT mode  |                       | tcc ÷ n − 3                      |   |      | ns   |    |
| CLKOUT rise/fall time                | <b>t</b> rfCO |   |                       |                                  |   | 5    | ns   |    |
| CLKOUT delay time                    | tdCO          | $IV_{DD} = 2.0 \text{ to } 2.7 \text{ V}$ $IV_{DD} = 2.3 \text{ to } 2.7 \text{ V}$ |                       |                                  |   | 20   | ns   |    |
|                                      |               |   |                       |                                  |   | 15   | ns   |    |

Note m: Multiple, n: Division ratio, I: HALT division ratio



# Clock I/O timing





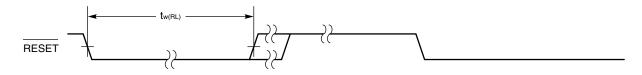
#### Reset, Interrupt

#### **Timing requirements**

| Parameter                    | Symbol       | Condition | MIN.                  | TYP. | MAX. | Unit |
|------------------------------|--------------|-----------|-----------------------|------|------|------|
| RESET low-level width        | tw (RL)      |           | 6 tcc <sup>Note</sup> |      |      | ns   |
| WAKEUP low-level width       | tw (WAKEUPL) |           | 6 t₀c                 |      |      | μs   |
| INT1 to INT4 low-level width | tw (INTL)    |           | 3 tcc <sup>Note</sup> |      |      | ns   |
| INT1 to INT4 recovery time   | trec (INT)   |           | 3 t₀c                 |      |      | ns   |

**Note** Note that t<sub>CC</sub> is I (I = integer of 1 to 16) times that during normal operation in the HALT mode.

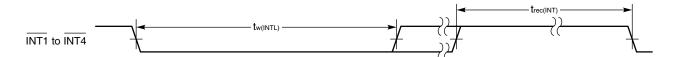
#### **Reset timing**



#### **★** WAKEUP timing



## Interrupt timing





## Serial Interface (Audio Serial mode)

## **Timing requirements**

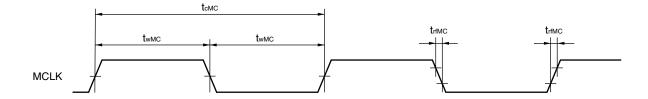
| Parameter                  | Symbol           | Condition   | MIN.                      | TYP. | MAX. | Unit |
|----------------------------|------------------|-------------|---------------------------|------|------|------|
| MCLK cycle time            | t <sub>cMC</sub> | Master mode | 40                        |      |      | ns   |
| MCLK high-/low-level width | twMC             | Master mode | $0.4 	imes t_{	ext{cMC}}$ |      |      | ns   |
| MCLK rise/fall time        | trfMC            | Master mode |                           |      | Note | ns   |
| BCLK cycle time            | t₀вc             | Slave mode  | 300                       |      |      | ns   |
| BCLK high-/low-level width | twBC             | Slave mode  | 120                       |      |      | ns   |
| BCLK rise/fall time        | trfBC            | Slave mode  |                           |      | 20   | ns   |
| LRCLK setup time           | tsu(BC-LR)       | Slave mode  | 50                        |      |      | ns   |
| SI setup time              | tsuSI            |             | 50                        |      |      | ns   |
| SI hold time               | thsi             |             | 50                        |      |      | ns   |

Note 5 or maximum value of  $0.1 \times t_{\text{cMC}}$ 

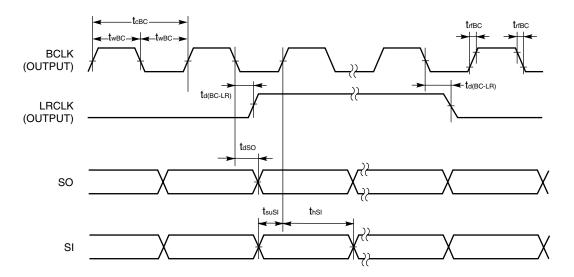
| Parameter                  | Symbol        | Condition                | MIN.                 | TYP.    | MAX. | Unit |
|----------------------------|---------------|--------------------------|----------------------|---------|------|------|
| BCLK cycle time            | t₀вс          | Master mode, 64-bit mode |                      | 1/64 fs |      | ns   |
|                            |               | Master mode, 32-bit mode |                      | 1/32 fs |      | ns   |
| BCLK high-/low-level width | twBC          | Master mode              | 0.4 t <sub>cBC</sub> |         |      | ns   |
| BCLK rise/fall time        | <b>t</b> riBC | Master mode              |                      |         | 20   | ns   |
| LRCLK delay time           | td(BC-LR)     | Master mode              | -40                  |         | +40  | ns   |
| SO output delay time       | tdSO          |                          | -40                  |         | +40  | ns   |



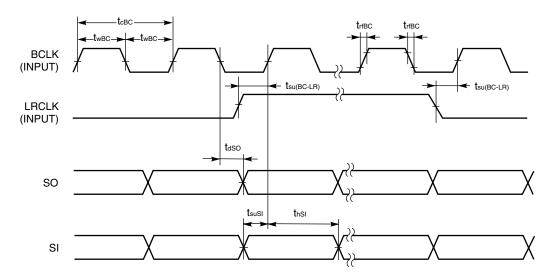
#### **Audio Serial clock timing**



#### **Audio Serial Master mode timing**



## **Audio Serial Slave mode timing**





## Serial Interface (Standard Serial mode)

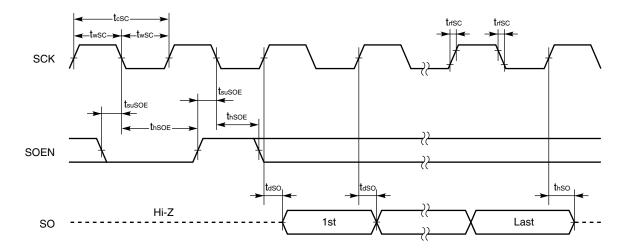
## **Timing requirements**

| Parameter                 | Symbol | Condition                       | MIN.        | TYP. | MAX. | Unit |
|---------------------------|--------|---------------------------------|-------------|------|------|------|
| SCK cycle time            | tcsc   |                                 | 60 and 2tcc |      |      | ns   |
| SCK high-/low-level width | twsc   |                                 | 25          |      |      | ns   |
| SCK rise/fall time        | trisc  |                                 |             |      | 20   | ns   |
| SOEN setup time           | tsuSOE | IV <sub>DD</sub> = 2.0 to 2.7 V | 10          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 5           |      |      | ns   |
| SOEN hold time            | thsoe  | IV <sub>DD</sub> = 2.0 to 2.7 V | 15          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 10          |      |      | ns   |
| SIEN setup time           | tsuSIE | IV <sub>DD</sub> = 2.0 to 2.7 V | 10          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 5           |      |      | ns   |
| SIEN hold time            | thsiE  | IV <sub>DD</sub> = 2.0 to 2.7 V | 15          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 10          |      |      | ns   |
| SI setup time             | tsuSI  | IV <sub>DD</sub> = 2.0 to 2.7 V | 10          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 5           |      |      | ns   |
| SI hold time              | thsi   | IV <sub>DD</sub> = 2.0 to 2.7 V | 15          |      |      | ns   |
|                           |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 10          |      |      | ns   |

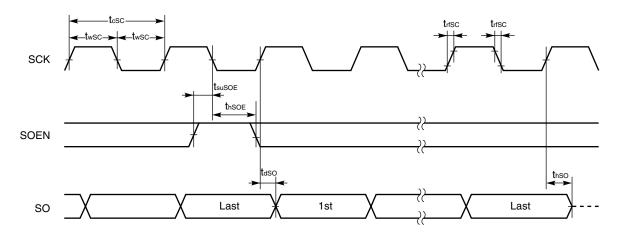
| Parameter            | Symbol | Condition                       | MIN. | TYP. | MAX. | Unit |
|----------------------|--------|---------------------------------|------|------|------|------|
| SO output delay time | tdso   | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 30   | ns   |
|                      |        | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 25   | ns   |
| SO hold time         | thso   |                                 | 0    |      |      | ns   |



## Serial output timing 1

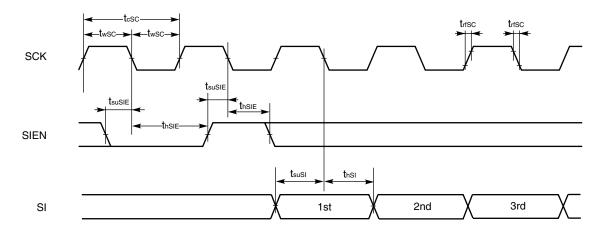


## Serial output timing 2 (during successive output)

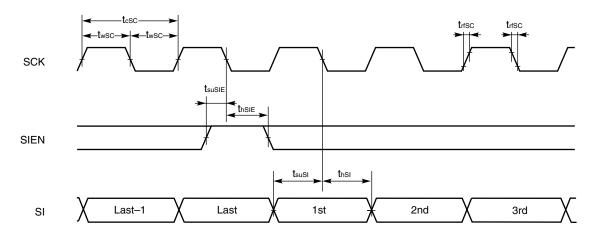




## Serial input timing 1

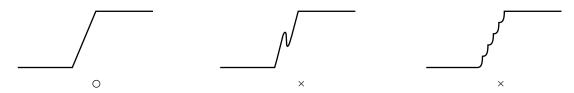


## Serial input timing 2 (during successive input)



Caution If noise is superimposed on the serial clock, the serial interface may be deadlocked. Bear in mind the following points when designing your system:

- Reinforce the wiring for power supply and ground (if noise is superimposed on the power and ground lines, it has the same effect as if noise were superimposed on the serial clock).
- Shorten the wiring between the device's SCK pin, and clock supply source.
- Do not cross the signal lines of the serial clock with any other signal lines. Do not route the serial clock line in the vicinity of a line through which a high alternating current flows.
- Supply the clock to the SCK pin of the device from the clock source on a one-to-one basis. Do
  not supply clock to several devices from one clock source.
- Exercise care that the serial clock does not overshoot or undershoot. In particular, make sure that the rising and falling of the serial clock waveform are clear.



Make sure that the serial clock rises and falls linearly.

The serial clock must not bound. Noise must not be superimposed on the serial clock.

The serial clock must not rise or fall step-wise.



#### **Host Interface**

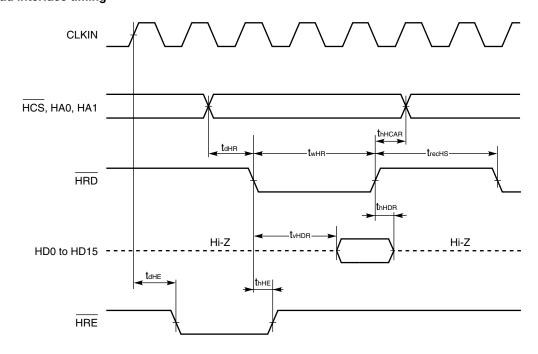
## **Timing requirements**

| Parameter                     | Symbol | Condition                       | MIN.         | TYP. | MAX. | Unit |
|-------------------------------|--------|---------------------------------|--------------|------|------|------|
| HRD delay time                | tdHR   | IV <sub>DD</sub> = 2.0 to 2.7 V | 15           |      |      | ns   |
|                               |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 5            |      |      | ns   |
| HRD width                     | twHR   |                                 | 40           |      |      | ns   |
| HCS, HA0, HA1, read hold time | thHCAR |                                 | 0            |      |      | ns   |
| HCS, HA0, HA1 write hold time | thHCAW |                                 | 0            |      |      | ns   |
| HRD, HWR recovery time        | trecHS |                                 | <b>3t</b> ₀c |      |      | ns   |
| HWR delay time                | taHW   | IV <sub>DD</sub> = 2.0 to 2.7 V | 15           |      |      | ns   |
|                               |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 10           |      |      | ns   |
| HWR width                     | twHW   |                                 | 40           |      |      | ns   |
| HWR hold time                 | thHDW  |                                 | 0            |      |      | ns   |
| HWR setup time                | tsuHDW | IV <sub>DD</sub> = 2.0 to 2.7 V | 15           |      |      | ns   |
|                               |        | IV <sub>DD</sub> = 2.3 to 2.7 V | 10           |      |      | ns   |

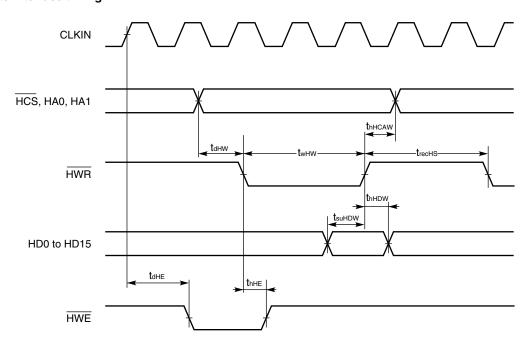
| Parameter                  | Symbol       | Condition                       | MIN. | TYP. | MAX. | Unit |
|----------------------------|--------------|---------------------------------|------|------|------|------|
| HRE, HWE output delay time | <b>t</b> aHE | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 30   | ns   |
|                            |              | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 25   | ns   |
| HRE, HWE hold time         | thHE         | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 30   | ns   |
|                            |              | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 25   | ns   |
| HRD valid time             | tvHDR        | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 30   | ns   |
|                            |              | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 25   | ns   |
| HRD hold time              | thHDR        |                                 | 0    |      |      | ns   |



#### Host read interface timing



## Host write interface timing





## General-purpose I/O Port

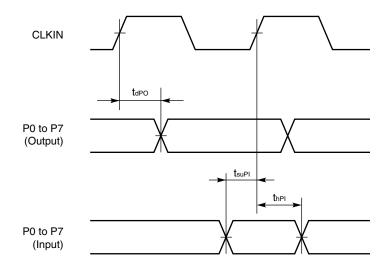
## **Timing requirements**

| Parameter             | Symbol        | Condition                       | MIN. | TYP. | MAX. | Unit |
|-----------------------|---------------|---------------------------------|------|------|------|------|
| Port input setup time | <b>t</b> suPI |                                 | 0    |      |      | ns   |
| Port input hold time  | <b>t</b> hPI  | IV <sub>DD</sub> = 2.0 to 2.7 V | 15   |      |      | ns   |
|                       |               | IV <sub>DD</sub> = 2.3 to 2.7 V | 10   |      |      | ns   |

## **Switching characteristics**

| Parameter              | Symbol | Condition                       | MIN. | TYP. | MAX. | Unit |
|------------------------|--------|---------------------------------|------|------|------|------|
| Port output delay time | tdPO   | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 30   | ns   |
|                        |        | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 25   | ns   |

## General-purpose I/O port timing





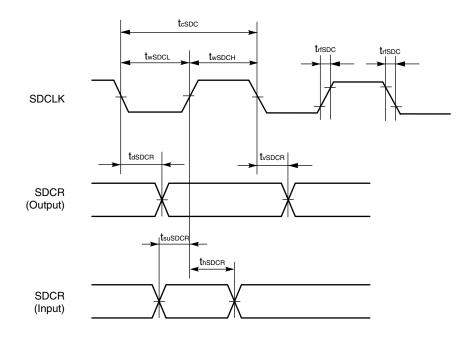
#### **SD** card Interface

## **Timing requirements**

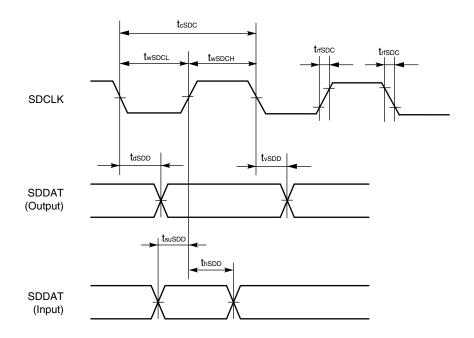
| Parameter              | Symbol  | Condition      | MIN. | TYP. | MAX. | Unit |
|------------------------|---------|----------------|------|------|------|------|
| SDCR input setup time  | tsuSDCR | Input Response | 5    |      |      | ns   |
| SDCR input hold time   | thSDCR  | Input Response | 0    |      |      | ns   |
| SDDAT input setup time | tsuSDD  | Input data     | 5    |      |      | ns   |
| SDDAT input hold time  | thspp   | Input data     | 0    |      |      | ns   |

| Parameter               | Symbol | Condition      | MIN. | TYP. | MAX. | Unit |
|-------------------------|--------|----------------|------|------|------|------|
| SDCLK cycle time        | tcspc  |                | 40   |      |      | ns   |
| SDCLK high- level width | twspcн |                | 10   |      |      | ns   |
| SDCLK low-level width   | twspcl |                | 10   |      |      | ns   |
| SDCLK rise/fall time    | trispc |                |      |      | 10   | ns   |
| SDCR output delay time  | tdSDCR | Output Command |      |      | 10   | ns   |
| SDCR output valid time  | tvsdcr | Output Command | 0    |      |      | ns   |
| SDDAT output delay time | tdSDD  | Output data    |      |      | 10   | ns   |
| SDDAT output valid time | tvsdd  | Output data    | 0    |      |      | ns   |

## **SDCR timing**



# SDDAT timing





## **Debugging Interface (JTAG)**

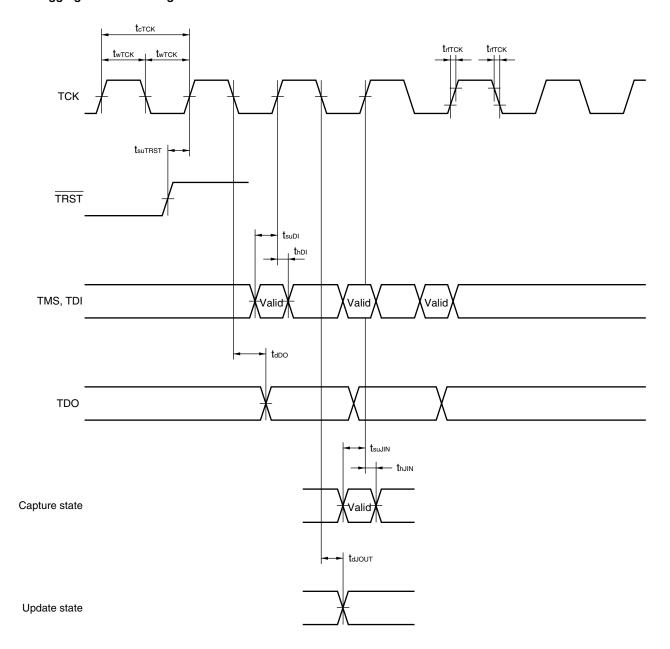
## **Timing requirements**

| Parameter                 | Symbol                    | Condition                       | MIN. | TYP. | MAX. | Unit |
|---------------------------|---------------------------|---------------------------------|------|------|------|------|
| TCK cycle time            | <b>t</b> cTCK             |                                 | 120  |      |      | ns   |
| TCK high-/low-level width | <b>t</b> wTCK             |                                 | 50   |      |      | ns   |
| TCK rise/fall time        | <b>t</b> <sub>rFTCK</sub> |                                 |      |      | 20   | ns   |
| TMS, TDI setup time       | tsuDI                     | IV <sub>DD</sub> = 2.0 to 2.7 V | 25   |      |      | ns   |
|                           |                           | IV <sub>DD</sub> = 2.3 to 2.7 V | 20   |      |      | ns   |
| TMS, TDI hold time        | thDI                      | IV <sub>DD</sub> = 2.0 to 2.7 V | 25   |      |      | ns   |
|                           |                           | IV <sub>DD</sub> = 2.3 to 2.7 V | 20   |      |      | ns   |
| Input pin setup time      | tsuJIN                    | IV <sub>DD</sub> = 2.0 to 2.7 V | 25   |      |      | ns   |
|                           |                           | IV <sub>DD</sub> = 2.3 to 2.7 V | 20   |      |      | ns   |
| Input pin hold time       | thJIN                     | IV <sub>DD</sub> = 2.0 to 2.7 V | 25   |      |      | ns   |
|                           |                           | IV <sub>DD</sub> = 2.3 to 2.7 V | 20   |      |      | ns   |
| TRST setup time           | tsuTRST                   |                                 | 100  |      |      | ns   |

| Parameter                    | Symbol | Condition                       | MIN. | TYP. | MAX. | Unit |
|------------------------------|--------|---------------------------------|------|------|------|------|
| TDO output delay time        | tdDO   | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 25   | ns   |
|                              |        | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 20   | ns   |
| Output pin output delay time | tыоит  | IV <sub>DD</sub> = 2.0 to 2.7 V |      |      | 25   | ns   |
|                              |        | IV <sub>DD</sub> = 2.3 to 2.7 V |      |      | 20   | ns   |



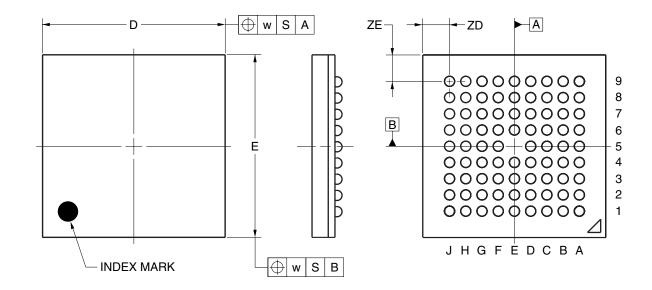
## **Debugging interface timing**

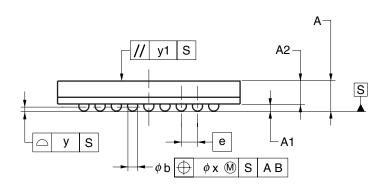


Remark For details of JTAG, refer to IEEE1149.1.

#### 9. PACKAGES

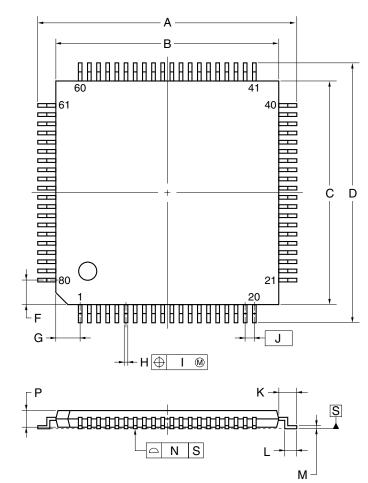
## \* 80-PIN PLASTIC FBGA (9x9)



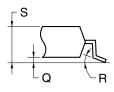


|      | (UNIT:mm)              |
|------|------------------------|
| ITEM | DIMENSIONS             |
| D    | 9.00±0.10              |
| Е    | 9.00±0.10              |
| w    | 0.20                   |
| Α    | 1.28±0.10              |
| A1   | 0.35±0.06              |
| A2   | 0.93                   |
| е    | 0.80                   |
| b    | $0.50^{+0.05}_{-0.10}$ |
| х    | 0.08                   |
| у    | 0.10                   |
| y1   | 0.20                   |
| ZD   | 1.30                   |
| ZE   | 1.30                   |
|      | P80F1-80-CN6           |

# 80-PIN PLASTIC TQFP (FINE PITCH) (12x12)



detail of lead end



#### NOTE

Each lead centerline is located within 0.10 mm of its true position (T.P.) at maximum material condition.

| ITEM | MILLIMETERS    |
|------|----------------|
| Α    | 14.0±0.2       |
| В    | 12.0±0.2       |
| С    | 12.0±0.2       |
| D    | 14.0±0.2       |
| F    | 1.25           |
| G    | 1.25           |
| Н    | 0.22±0.05      |
| I    | 0.10           |
| J    | 0.5 (T.P.)     |
| K    | 1.0±0.2        |
| L    | 0.5±0.2        |
| М    | 0.145±0.05     |
| N    | 0.10           |
| Р    | 1.0±0.05       |
| Q    | 0.1±0.05       |
| R    | 3°+7°          |
| S    | 1.2 MAX.       |
|      | S80GK-50-9EU-1 |



#### 10. RECOMMENDED SOLDERING CONDITIONS

It is recommended to solder this product under the following conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

#### **Surface-Mount Type**

•  $\mu$  PD77115GK-9EU: 80-pin plastic TQFP (fine-pitch) (12 × 12)

| Soldering Process      | Soldering Conditions   | Symbol     |
|------------------------|--|------------|
| Infrared ray reflow    | Package peak temperature: 235°C, Time: 30 seconds MAX (210°C MIN), Number of times: 2 MAX, Number of days: 3 <sup>Note</sup> (after that, prebaking is necessary for 10 to 72 hours at 125°C)) | IR35-103-2 |
| VPS                    | Package peak temperature: 215°C, Time: 40 seconds MAX (200°C MIN), Number of times: 2 MAX, Number of days: 3 <sup>Note</sup> (after that, prebaking isnecessary for 10 to 72 hours at 125°C)   | VP15-103-2 |
| Partial heating method | Pin temperature: 300°C MAX, Time: 3 seconds MAX (per side of device)   | _          |

- $\mu$  PD77115F1-CN6: 80-pin plastic FBGA (9 × 9)
- ★  $\mu$  PD77115AF1-xxx-CN6: 80-pin plastic FBGA (9 × 9)

| Soldering Process   | Soldering Conditions   | Symbol     |
|---------------------|--|------------|
| Infrared ray reflow | Package peak temperature: 235°C, Time: 30 seconds MAX (210°C MIN), Number of times: 2 MAX, Number of days: 3 <sup>Note</sup> (after that, prebaking is necessary for 10 to 72 hours at 125°C)) | IR35-103-2 |
| VPS                 | Package peak temperature: 215°C, Time: 40 seconds MAX (200°C MIN), Number of times: 2 MAX, Number of days: 3 <sup>Note</sup> (after that, prebaking isnecessary for 10 to 72 hours at 125°C)   | VP15-103-2 |

**Note** Number of days in storage after the dry pack has been opened. The storage conditions are at 25°C, 65% RH MAX.

Caution Apply wave soldering only to the pins and be careful not to bring solder into direct contact with the package.

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- · Device availability
- · Ordering information
- · Product release schedule
- · Availability of related technical literature
- · Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- Network requirements

In addition, trademarks, registered trademarks, export restrictions, and other legal issues may also vary from country to country.

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Novena Square, Singapore

Tel: 6253-8311

J04.1

#### NOTES FOR CMOS DEVICES —

#### 1 VOLTAGE APPLICATION WAVEFORM AT INPUT PIN

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{\rm IL}$  (MAX) and  $V_{\rm IH}$  (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{\rm IL}$  (MAX) and  $V_{\rm IH}$  (MIN).

#### (2) HANDLING OF UNUSED INPUT PINS

Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

#### ③ PRECAUTION AGAINST ESD

A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

#### (4) STATUS BEFORE INITIALIZATION

Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

#### ⑤ POWER ON/OFF SEQUENCE

In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current.

The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

#### **6** INPUT OF SIGNAL DURING POWER OFF STATE

Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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